

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HYUNKI KIM	12/21/2015
SEUNGJE PARK	12/21/2015
RECEIVING PARTY DATA	
Name:	LG ELECTRONICS INC.
Street Address:	128, YEOUNI-DAERO, YEONGDEUNGPO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	07336
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14977605
CORRESPONDENCE DATA	
Fax Number:	(703)766-3644
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7037663777
Email:	ked-docket@ked-iplaw.com
Correspondent Name:	KED & ASSOCIATES, LLP
Address Line 1:	P.O. BOX 8638
Address Line 4:	RESTON, VIRGINIA 20195
ATTORNEY DOCKET NUMBER:	HI-1153
NAME OF SUBMITTER:	DANIEL Y.J. KIM
SIGNATURE:	/Daniel Y.J. Kim/
DATE SIGNED:	12/21/2015
Total Attachments: 1	
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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- | | |
|-------------------------|-----------|
| (1) <u>Hyunki KIM</u> | (4) _____ |
| (2) <u>Seungje PARK</u> | (5) _____ |
| (3) _____ | (6) _____ |

who have made a certain new and useful invention, hereby sell, assign and transfer unto

LG ELECTRONICS INC.
128, Yeoui-daero, Yeongdeungpo-gu
Seoul, 07336, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

TOUCH SENSOR ASSEMBLY AND METHOD OF MANUFACTURING SAME

(a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on December 21, 2015

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and/or that claim priority thereto and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof and/or that claim priority thereto, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

AND the undersigned hereby grants the firm of KED & ASSOCIATES, LLP the power to insert on this assignment any further identification that may be necessary or desirable in order to comply with the rules of any issuing authority, including the United States Patent and Trademark Office, for recordation of this document.

SIGNED on the dates indicated aside our signatures:

INVENTORS		DATE SIGNED
1) <u>Hyunki Kim</u>	Name: <u>Hyunki KIM</u>	<u>2015.12.21</u>
2) <u>Seungje Park</u>	Name: <u>Seungje PARK</u>	<u>2015.12.21</u>
3) _____	Name: _____	_____
4) _____	Name: _____	_____
5) _____	Name: _____	_____
6) _____	Name: _____	_____